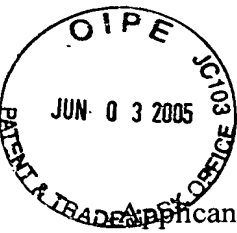


2814

Examiner : Alonzo Chambliss
 Art Unit : 2814
 Docket No. : 52433/609



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : K. TATSUMI et al.
 Serial No. : 09/632,910
 Filed : August 4, 2000
 For : METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE
 PROVIDED WITH LOW MELTING POINT METAL BUMPS

Commissioner for Patents
 P.O. Box 1450
 Alexandria, VA 22313-1450

TRANSMITTAL LETTER

SIR:

Transmitted herewith is an Amendment/Response in the above-identified patent application.

[X] No additional fee is required.

The fee has been calculated as shown below.

					SMALL ENTITY		OTHER THAN A SMALL ENTITY	
CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDIT. OR FEE	RATE	ADDIT. FEE		
TOTAL 8	MINUS 20	= 0	x6=	\$	x18 =	\$	0.00	
INDEP. 2	MINUS 3	= 0	x18=	\$	x84 =	\$	0.00	
[] FIRST PRESENTATION OF MULTIPLE			x60=	\$	x280=	\$	0.00	
DEP. CLAIM			TOTAL ADDIT. FEE	\$	OR	\$	0.00	

[X] The Commissioner is hereby authorized to charge fees under 37 CFR 1.16 and 1.17 which may be required to Deposit Account 11-0600. A duplicate of this paper is enclosed.

[X] A petition for a one (1) month extension of time and Deposit Account authorization to cover the extension fee are enclosed.

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 31, 2005.

John J. Kelly, Jr. Reg. No. 29,182

Respectfully submitted,

KENYON & KENYON

By:
 John J. Kelly, Jr.
 Reg. No. 29,182

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 31, 2005.

John J. Kelly, Jr.
John J. Kelly, Jr. Reg. No.: 29,182

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RESPONSE

SIR:

Reconsideration of the above-identified patent application is respectfully requested. This response is in reply to the Office Action mailed February 1, 2005. A petition for an extension of time in which to reply to the Office Action accompanies this response.

Claims 16-19 and 25 are pending in the application. Claims 16 and 17 are the independent claims.